

RESmap

High precision resistivity mapping

Automated SiC Process Control

Deviations in resistivity within SiC crystals are of significant interest for material processing and quality control. The eddy-current based RESmap device offers high sensitivity and repeatability through integrated temperature compensation and self-calibration routines.





Learn more

Si, SiC, GaN, GaAs, InP and more

Materials

Automated X-Y mapping stage

Single and multi-point measurement, resolution: 1 + 0.1 mm

Resistivity range
1-100
mOhmcm

>20
Wafers/hour throughput



Freiberg **Instruments**



RESmap



Wafers, boules + ingots slabs

Processing geometries

Compliant with

SEMI MF 673 3

Models: Handheld, automation ready and fully automatic with robotic arms

Integrated distance and temp sensors

± 5 % accuracy

Effortless calibration

Reducing setup time and ensuring long-term reliability